

STARPOWER

SEMICONDUCTOR™

IGBT

GD150HTT170C7S

Molding Type Module

1700V/150A 6 in one-package

General Description

STARPOWER IGBT power module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- Low switching losses
- Maximum junction temperature 175°C
- 10 μ s short circuit capability
- Square RBSOA
- $V_{CE(sat)}$ with positive temperature coefficient
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

IGBT-inverter $T_C=25^\circ\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD150HTT170C7S	Units
V_{CES}	Collector-Emitter Voltage @ $T_j=25^\circ\text{C}$	1700	V
V_{GES}	Gate-Emitter Voltage @ $T_j=25^\circ\text{C}$	± 20	V
I_C	Collector Current @ $T_C=25^\circ\text{C}$ @ $T_C=80^\circ\text{C}$	300	A
		150	
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	300	A
P_{tot}	Total Power Dissipation @ $T_j=175^\circ\text{C}$	1250	W

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^\circ\text{C}$	1700			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V},$ $T_j=25^\circ\text{C}$			3.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V},$ $T_j=25^\circ\text{C}$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=6.0\text{mA}, V_{CE}=V_{GE},$ $T_j=25^\circ\text{C}$	5.2	5.8	6.4	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=150\text{A}, V_{GE}=15\text{V},$ $T_j=25^\circ\text{C}$		2.00	2.45	V
		$I_C=150\text{A}, V_{GE}=15\text{V},$ $T_j=125^\circ\text{C}$		2.40		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units	
R_{Gint}	Internal Gate Resistance			3.2		Ω	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=900\text{V}, I_C=150\text{A},$ $R_G=9.1\Omega, V_{GE}=\pm 15\text{V},$ $T_j=25^\circ\text{C}$		280		ns	
t_r	Rise Time			50		ns	
$t_{d(off)}$	Turn-Off Delay Time			815		ns	
t_f	Fall Time			180		ns	
E_{on}	Turn-On Switching Loss				33.1		mJ
E_{off}	Turn-Off Switching Loss				32.0		mJ

$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=900V, I_C=150A,$ $R_G=9.1\Omega, V_{GE}=\pm 15V,$ $T_j=125^\circ C$	300	ns
t_r	Rise Time		65	ns
$t_{d(off)}$	Turn-Off Delay Time		995	ns
t_f	Fall Time		300	ns
E_{on}	Turn-On Switching Loss		47.9	mJ
E_{off}	Turn-Off Switching Loss		47.1	mJ
C_{ies}	Input Capacitance	$V_{CE}=25V, f=1Mhz,$ $V_{GE}=0V$	13.2	nF
C_{oes}	Output Capacitance		0.55	nF
C_{res}	Reverse Transfer Capacitance		0.44	nF
I_{SC}	SC Data	$t_{sc} \leq 10\mu s, V_{GE} \leq 15V,$ $T_j=125^\circ C, V_{CC}=1000V,$ $V_{CEM} \leq 1700V$	600	A

DIODE-inverter $T_C=25^\circ C$ unless otherwise noted

Maximum Rated Values

Symbol	Description	GD150HTT170C7S	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^\circ C$	1700	V
I_F	DC Forward Current @ $T_C=80^\circ C$	150	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1ms$	300	A

Characteristics Values

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=150A, V_{GE}=0V$	$T_j=25^\circ C$	1.80	2.20	V
			$T_j=125^\circ C$	1.90		
Q_r	Recovered Charge	$I_F=150A,$	$T_j=25^\circ C$	40		μC
			$T_j=125^\circ C$	64		
I_{RM}	Peak Reverse Recovery Current	$V_R=900V,$ $di/dt=-2100A/\mu s,$	$T_j=25^\circ C$	176		A
			$T_j=125^\circ C$	190		
E_{rec}	Reverse Recovery Energy	$V_{GE}=-15V$	$T_j=25^\circ C$	20.0		mJ
			$T_j=125^\circ C$	35.9		

Electrical Characteristics of NTC $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
R_{25}	Rated Resistance			5.0		k Ω
$\Delta R/R$	Deviation of R_{100}	$T_C=100^{\circ}\text{C}, R_{100}=493.3\Omega$	-5		5	%
P_{25}	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		3375		K

IGBT Module

Symbol	Parameter	Min.	Typ.	Max.	Units
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}, t=1\text{min}$		3400		V
L_{CE}	Stray Inductance		20		nH
$R_{\text{CC'+EE'}}$	Module Lead Resistance, Terminal to Chip @ $T_C=25^{\circ}\text{C}$		1.1		m Ω
$R_{\theta\text{JC}}$	Junction-to-Case (per IGBT) Junction-to-Case (per DIODE)			0.120 0.210	K/W
$R_{\theta\text{CS}}$	Case-to-Sink (Conductive grease applied)		0.005		K/W
T_{jmax}	Maximum Junction Temperature			175	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40		125	$^{\circ}\text{C}$
Mounting Torque	Power Terminal Screw:M5 Mounting Screw:M6	3.0 3.0		6.0 6.0	N.m
Weight	Weight of Module		910		g

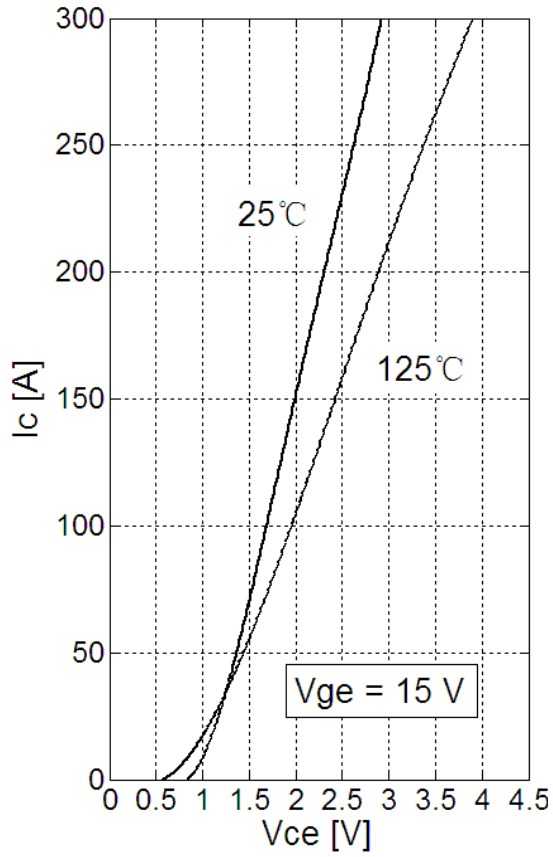


Fig 1. IGBT Output Characteristics

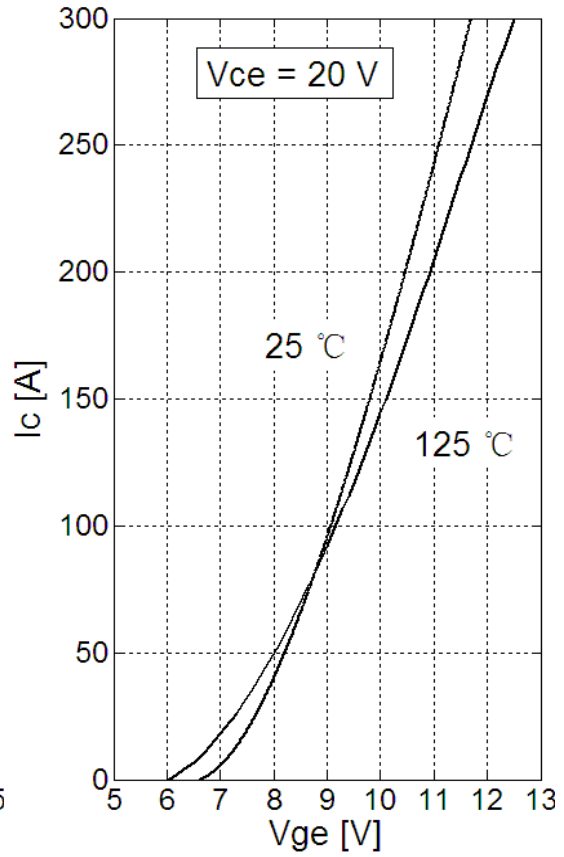


Fig 2. IGBT Transfer Characteristics

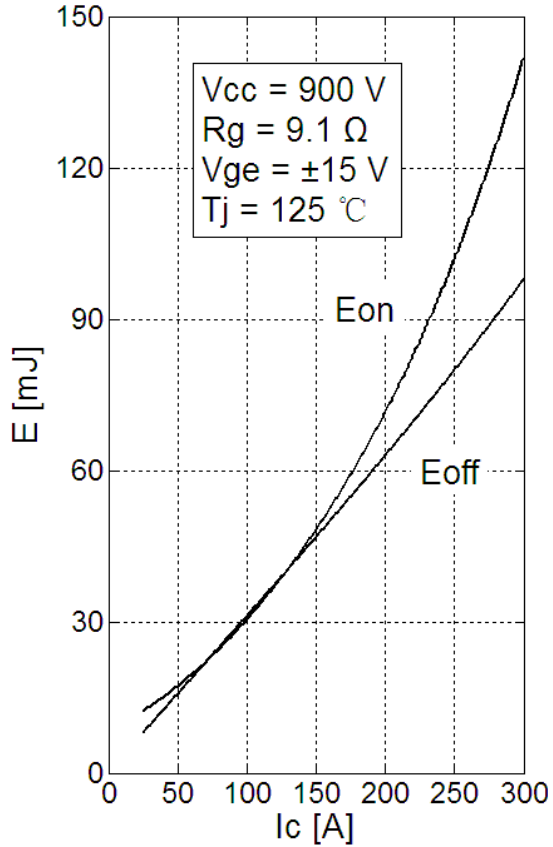


Fig 3. IGBT Switching Loss vs. I_c

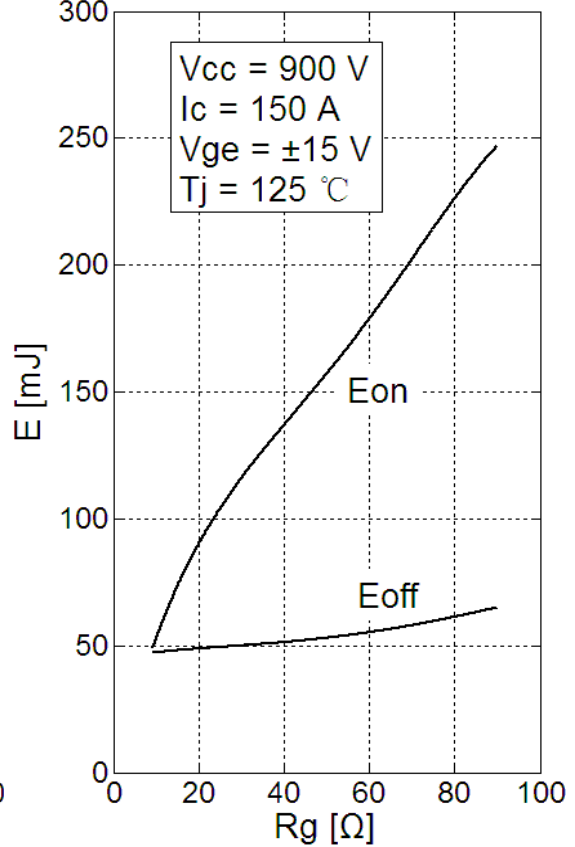


Fig 4. IGBT Switching Loss vs. R_g

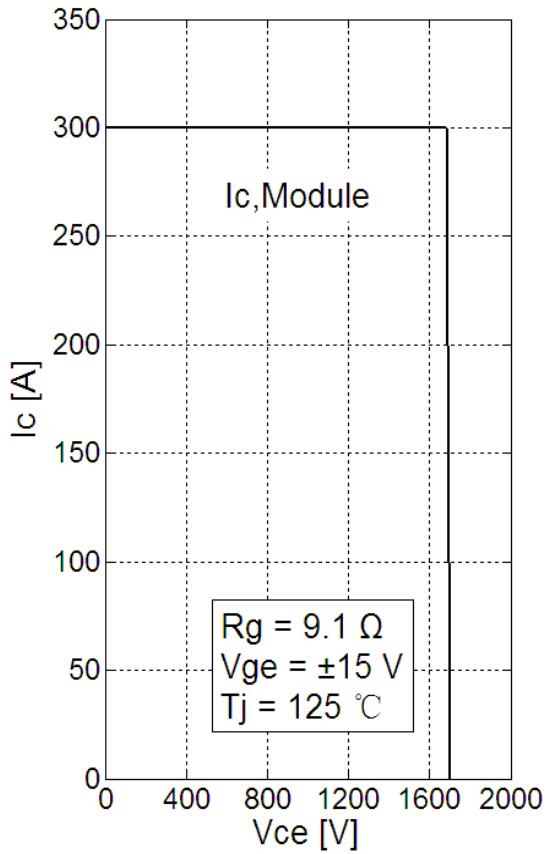


Fig 5. RBSOA

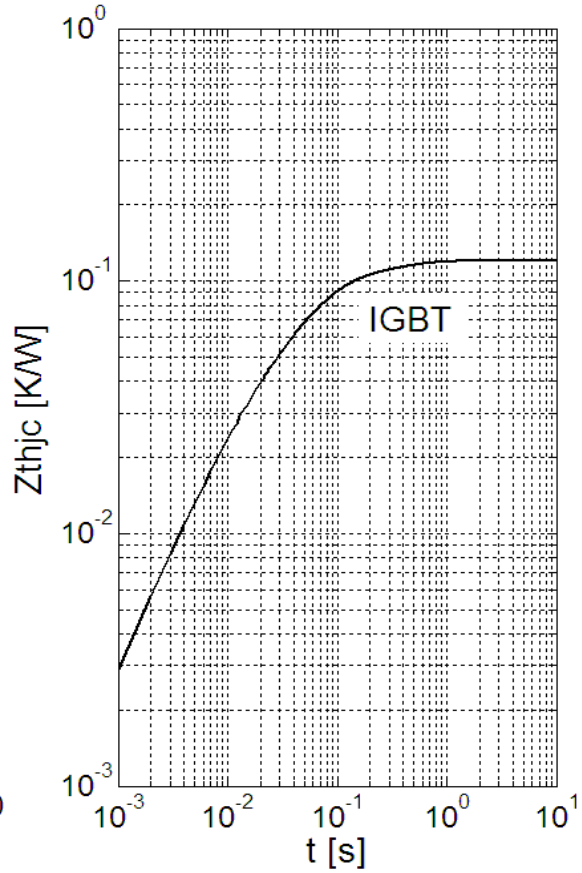


Fig 6. IGBT Transient Thermal Impedance

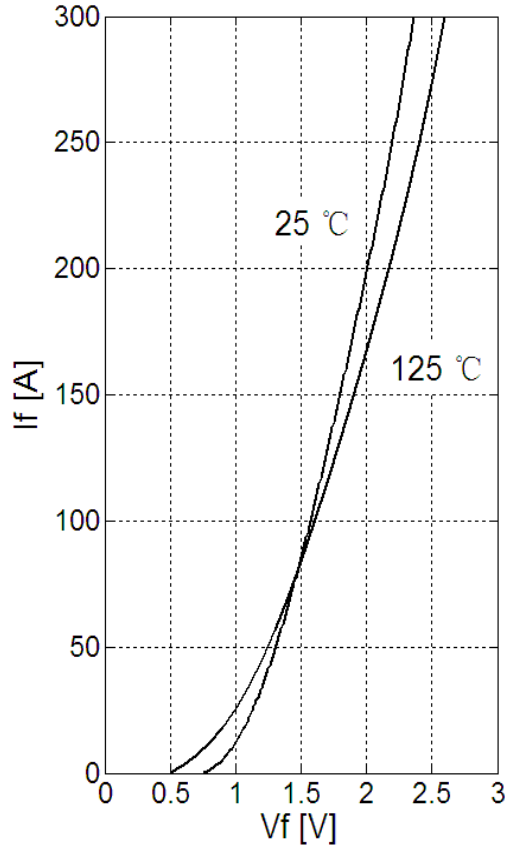


Fig 7. Diode Typical Forward Characteristics

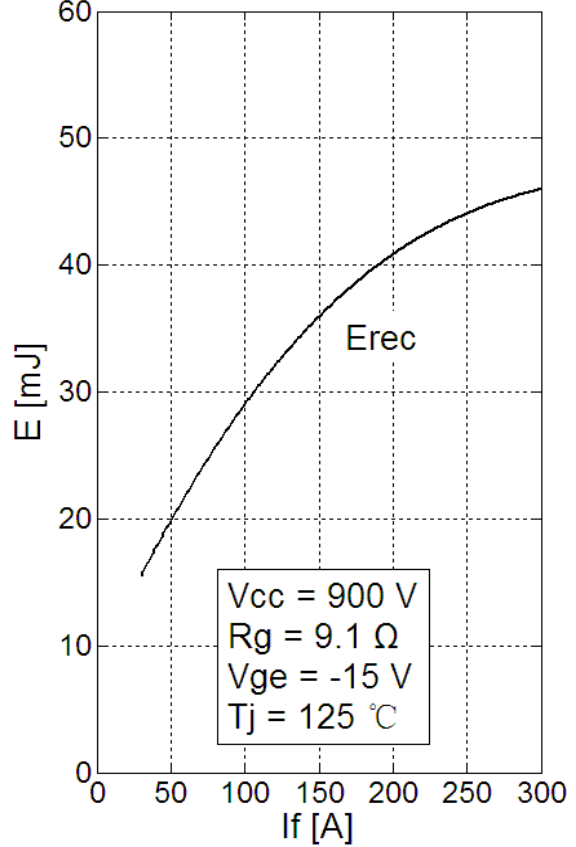


Fig 8. Diode Switching Loss vs. I_f

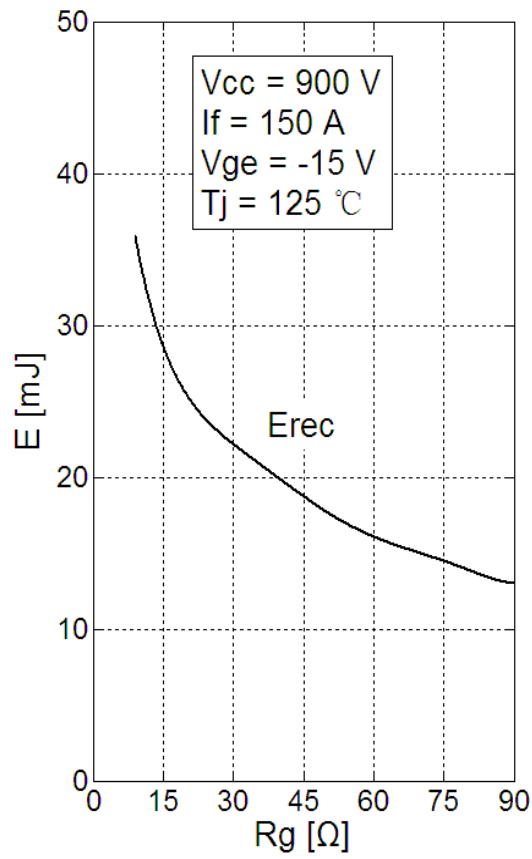


Fig 9. Diode Switching Loss vs. R_G

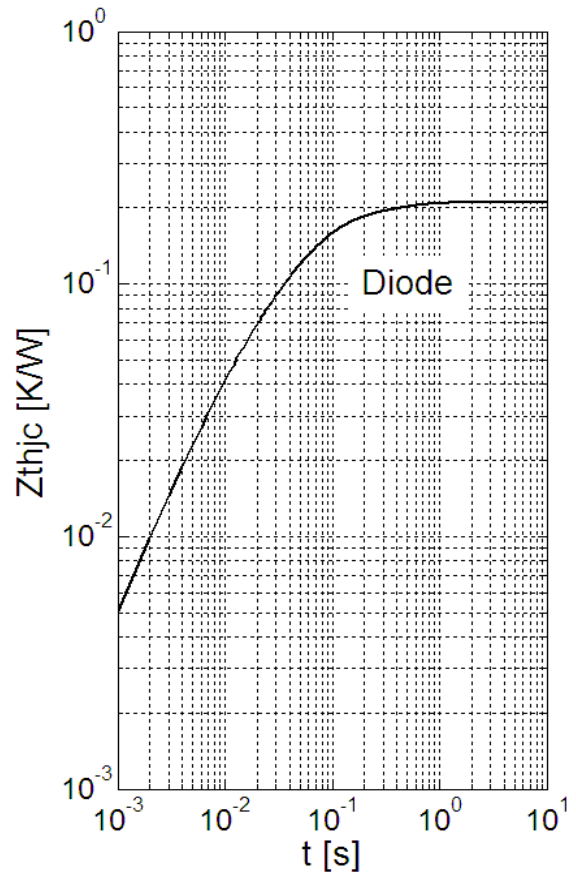


Fig 10. Diode Transient Thermal Impedance

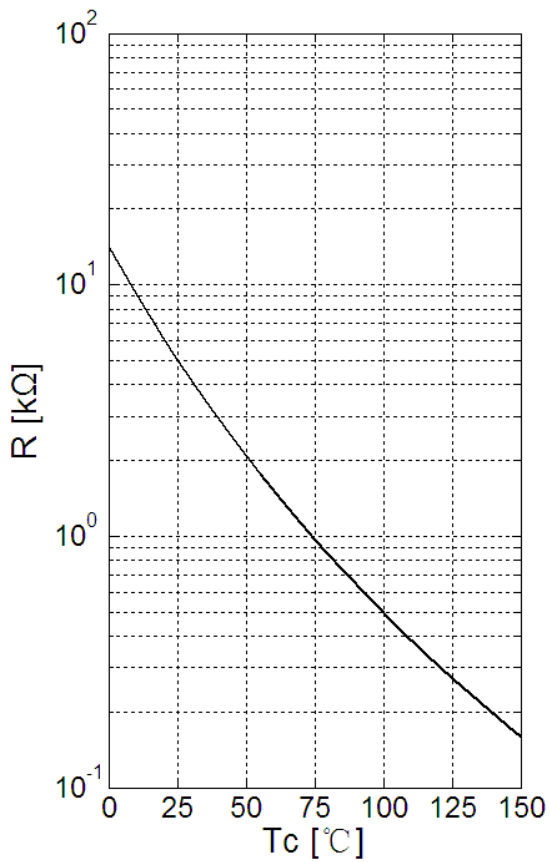
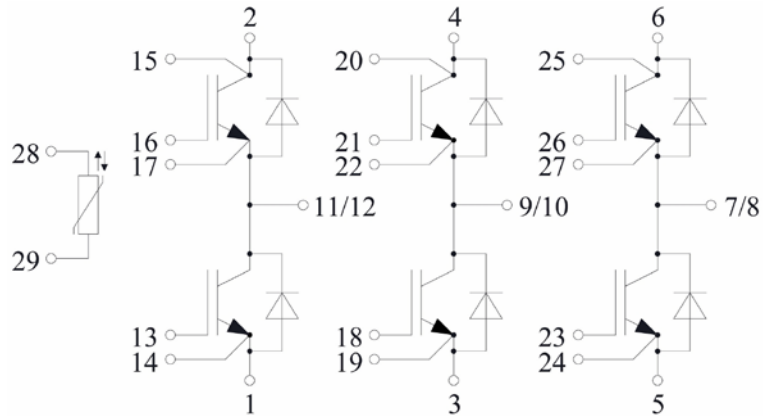


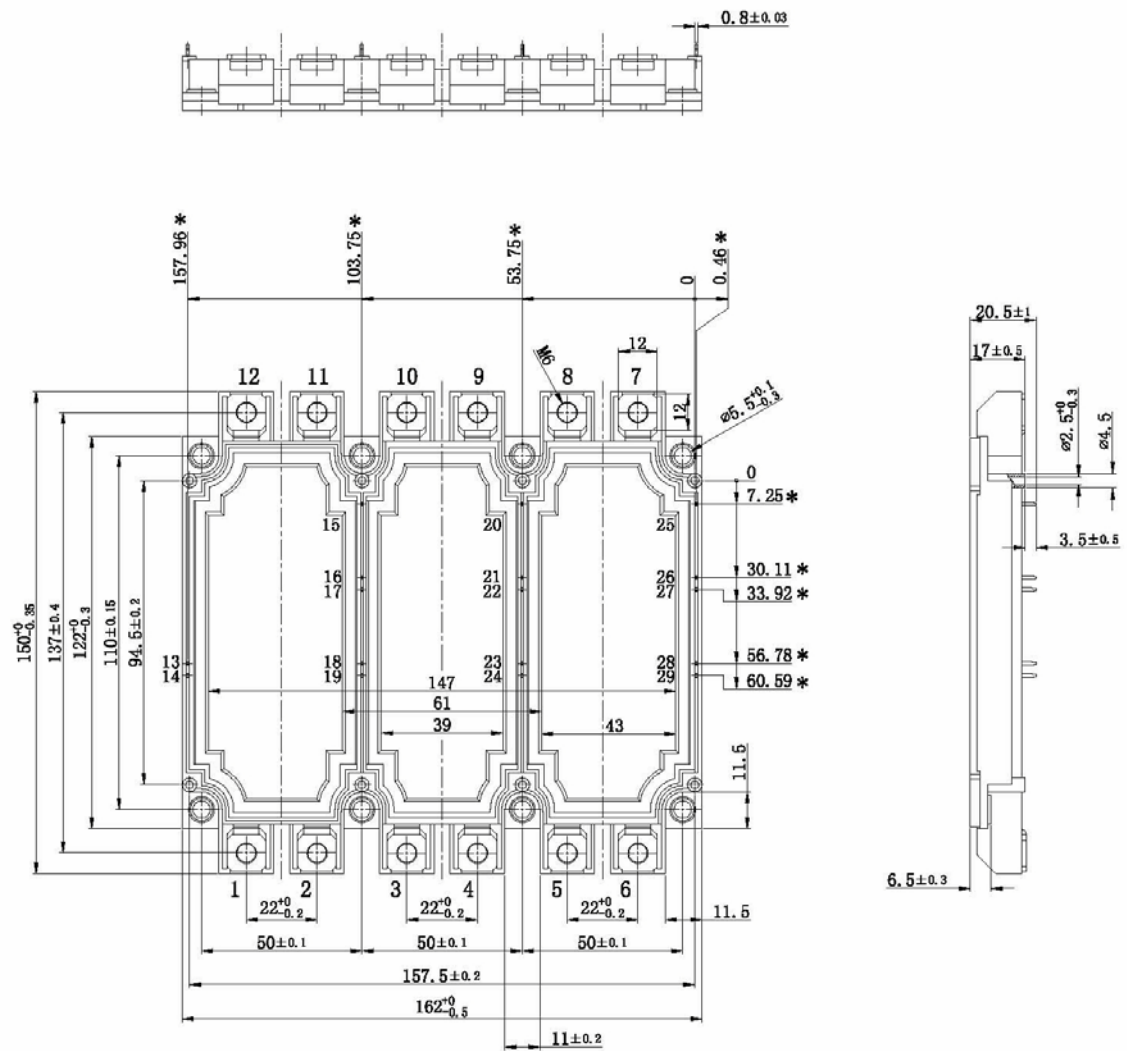
Fig 11. NTC-Temperature Characteristic

Equivalent Circuit Schematic



Package Dimension

Dimensions in Millimeters



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